# LNJ912W8BRA

Surface Mounting Chip LED

TSS Type

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P <sub>D</sub>	40	mW	
Forward current	I <sub>F</sub>	10	mA	
Pulse forward current	I <sub>FP</sub>	50	mA	
Reverse voltage	V <sub>R</sub>	5	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

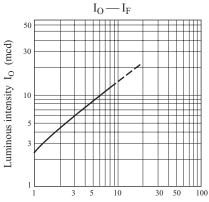
Lighting Color

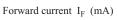
• Blue

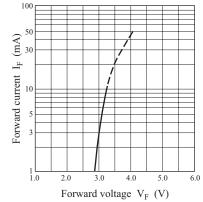
#### Electro-Optical Characteristics $T_a = 25^{\circ}C$

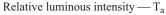
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	Io	$I_F = 5 \text{ mA}$	3.2	8.5		mcd
Reverse current	I <sub>R</sub>	$V_R = 5 V$			10	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 5 \text{ mA}$		3.2	3.7	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 5 \text{ mA}$		470		nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$		30		nm

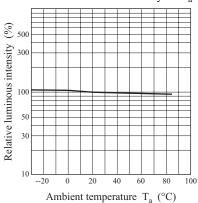
 $I_F - V_F$ 

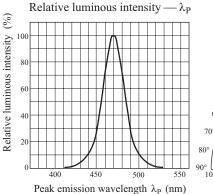


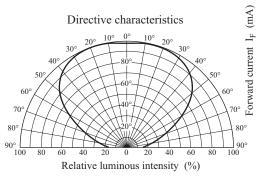


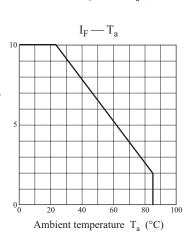






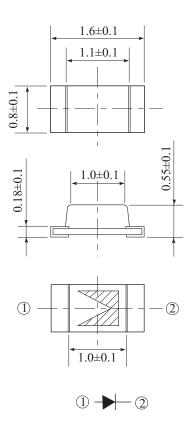






Package (Unit: mm)

### KLTFTN2K1200



• Pin name

1: Anode

2: Cathode

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